

General Description

It combines advanced trench MOSFET technology with a low resistance package to provide extremely low $R_{DS(ON)}$. It is suitable for automotive application.

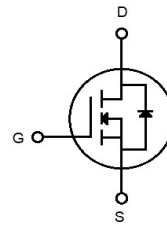
Features

- AEC-Q101 Qualified
- Low $R_{DS(ON)}$ to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance

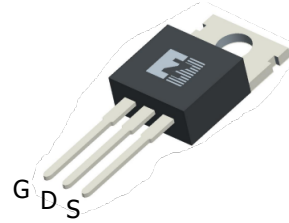
Application

- BLDC Motor driver
- DC-DC
- Load Switch

Product Summary



$V_{DS} = 100V$
 $R_{DS(ON)} = 2.7m\Omega$
 $I_D = 140A$



TO-220



Ordering Information:

Part NO.	ZMSA030N10HP
Marking	ZMS030N10H
Packing Information	Tube
Basic ordering unit (pcs)	1000

Absolute Maximum Ratings ($T_C=25^\circ C$)

Parameter	Symbol	Conditions	Value	Unit
Drain-Source Voltage	V_{DS}		100	V
Gate-Source Voltage ^①	V_{GS}		± 20	V
Continuous Drain Current	I_D	$T_C=25^\circ C$	140	A
	I_D	$T_C=75^\circ C$	123	A
	I_D	$T_C=100^\circ C$	107	A
Pulsed Drain Current	I_{DM}	Pulsed; $t_p \leq 10 \mu s$; $T_{mb} = 25^\circ C$;	560	A
Total Power Dissipation	P_D	$T_C=25^\circ C$	156	W
Total Power Dissipation	P_D	$T_A=25^\circ C$	3.1	W
Operating Junction Temperature	T_J		-55 to +175	$^\circ C$
Storage Temperature	T_{STG}		-55 to +175	$^\circ C$
Single Pulse Avalanche Energy	E_{AS}	$L=0.1mH$, $V_{GS}=10V$, $R_g=25\Omega$,	240	mJ
		$L=0.5mH$, $V_{GS}=10V$, $R_g=25\Omega$,	552	mJ
ESD Level (HBM)	CLASS 2			

•Thermal resistance

Parameter	Symbol	Min.	Typ.	Max.	Unit
Thermal resistance, junction - case	R_{thJC}		-	0.8	°C/W
Thermal resistance, junction-ambient	$R_{thJA}^{②}$		-	40	°C/W
Soldering temperature (total time<10s)	Tsold		-	265	°C

•Electronic Characteristics

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=250\mu A$	100			V
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{GS}=V_{DS}, I_D=250\mu A$	2.0	2.7	4.0	V
Drain-Source Leakage Current	I_{DSS}	$V_{GS}=0V, V_{DS}=100V$			1.0	μA
Gate- Source Leakage Current	I_{GSS}	$V_{GS}=\pm 20V, V_{DS}=0V$			100	nA
Static Drain-source On Resistance	$R_{DS(ON)}$	$V_{GS}=10V, I_D=40A$		2.7	3.4	m Ω
Forward Transconductance	g_{FS}	$V_{DS}=5V, I_{SD}=15A$		30		S
Diode Forward Voltage	V_{FSD}	$V_{GS}=0V, I_{SD}=40A$			1.3	V

•Dynamic characteristics

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Input capacitance	C_{iss}	$f=1MHz, V_{DS}=25V$	-	5490	-	pF
Output capacitance	C_{oss}		-	3060	-	
Reverse transfer capacitance	C_{rss}		-	309	-	
Gate Resistance	R_g	$f=1MHz$	-	1.5		Ω
Total gate charge	Q_g	$V_{DD}=15V, I_D=20A, V_{GS}=10V$	-	97	-	nC
Gate - Source charge	Q_{gs}		-	30	-	
Gate - Drain charge	Q_{gd}		-	19	-	
Turn-ON Delay time	$t_{D(on)}$	$V_{GS}=10V, V_{DS}=15V, R_G=3.3\Omega, I_D=20A$	-	11	-	ns
Turn-ON Rise time	t_r		-	42	-	ns
Turn-Off Delay time	$t_{D(off)}$		-	84	-	ns
Turn-Off Fall time	t_f		-	63	-	ns
Reverse Recovery Time	t_{RR}	$V_{DD}=20V, di_S/dt=100A/\mu s, I_S=50A$	-	75	-	ns
Reverse Recovery Charge	Q_{RR}		-	122	-	nC

Fig.1 Gate-Charge Characteristics

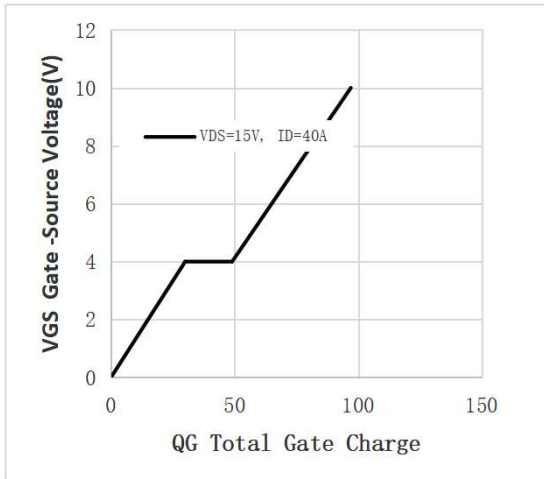


Fig.2 Capacitance Characteristics

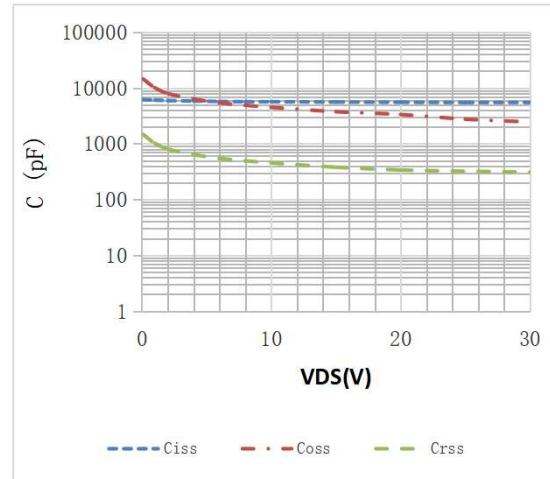


Fig.3 Power Dissipation

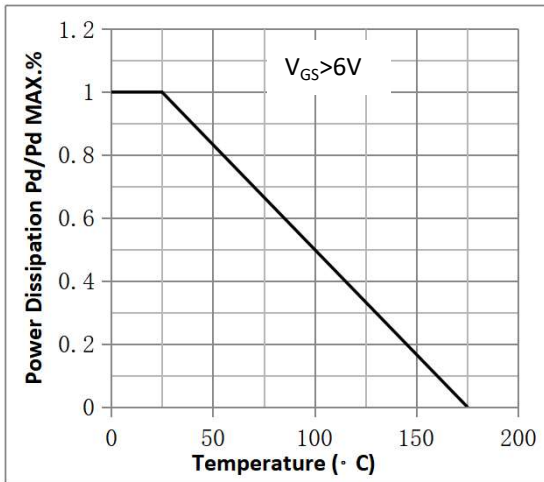


Fig.4 Typical output Characteristics

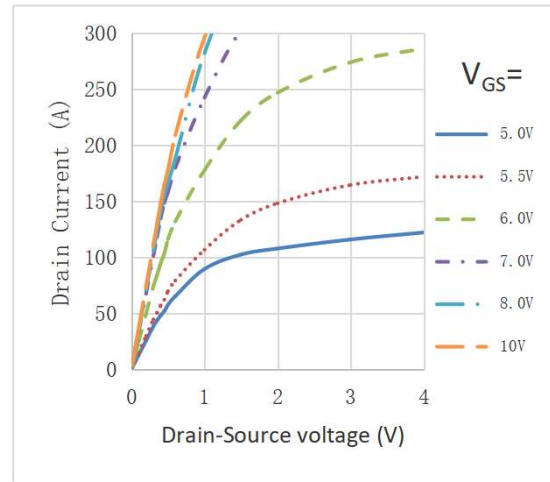


Fig.5 Threshold Voltage V.S Junction Temperature

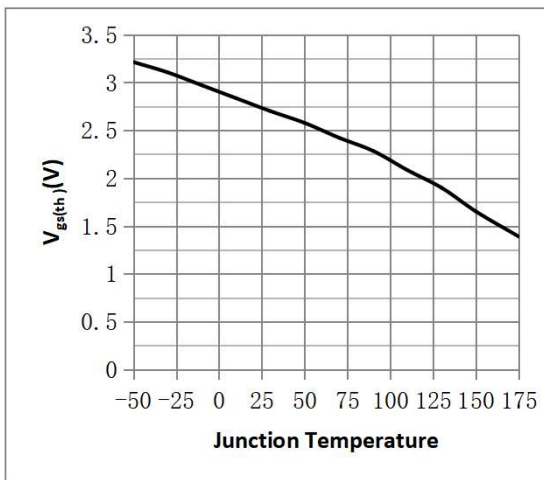


Fig.6 Resistance V.S Drain Current

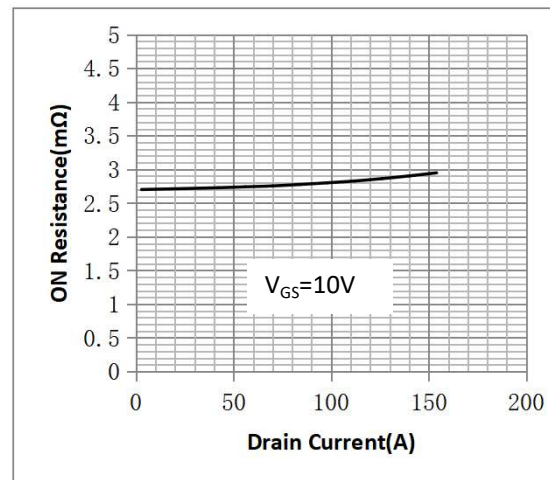


Fig.7 On-Resistance VS Gate Source Voltage

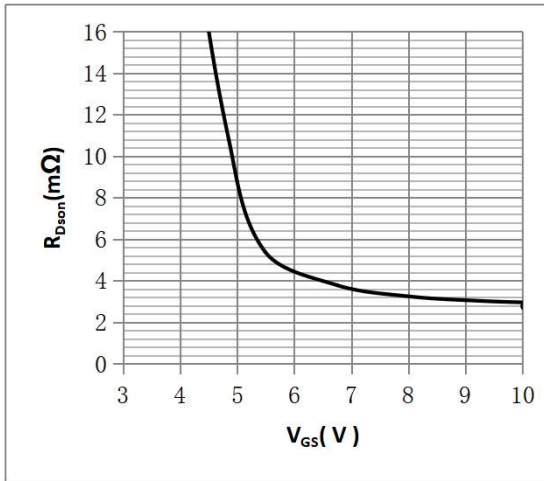


Fig.8 On-Resistance V.S Junction Temperature

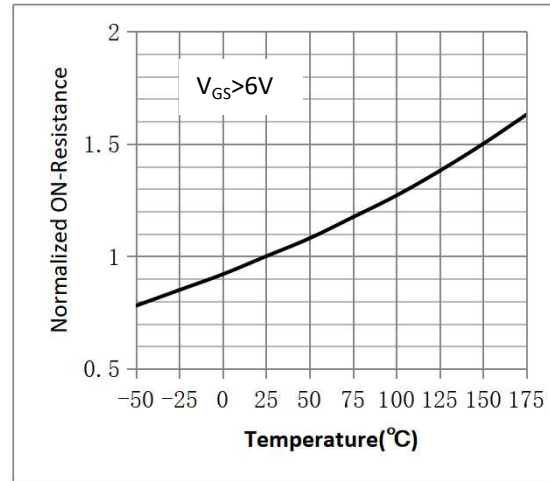


Figure 9. Diode Forward Voltage vs. Current

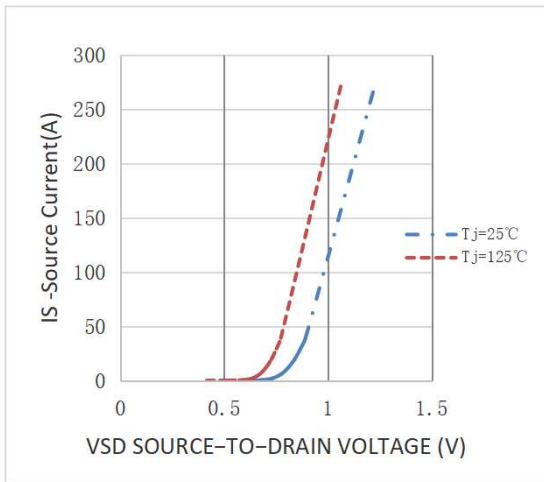


Figure 10. Transfer Characteristics

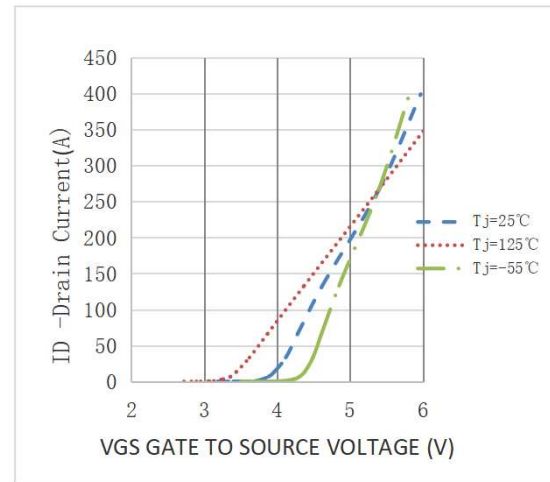


Fig.11 Safe Operating Area

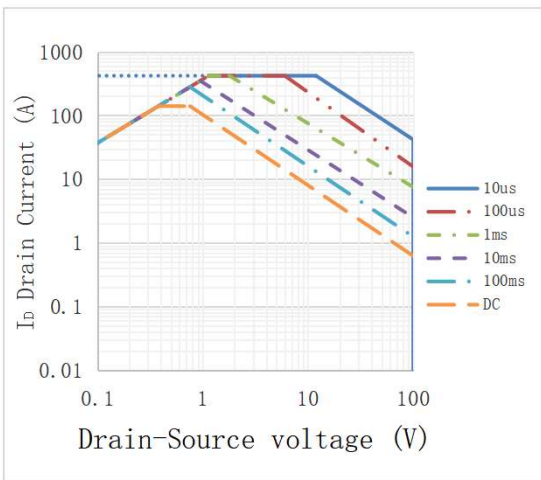
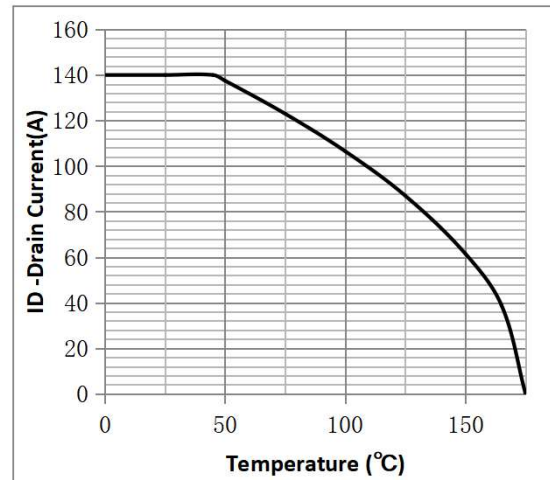
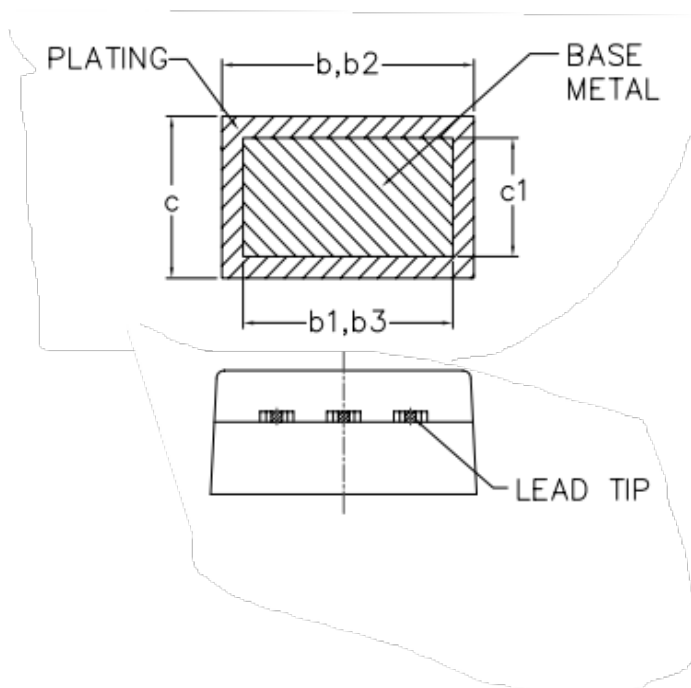
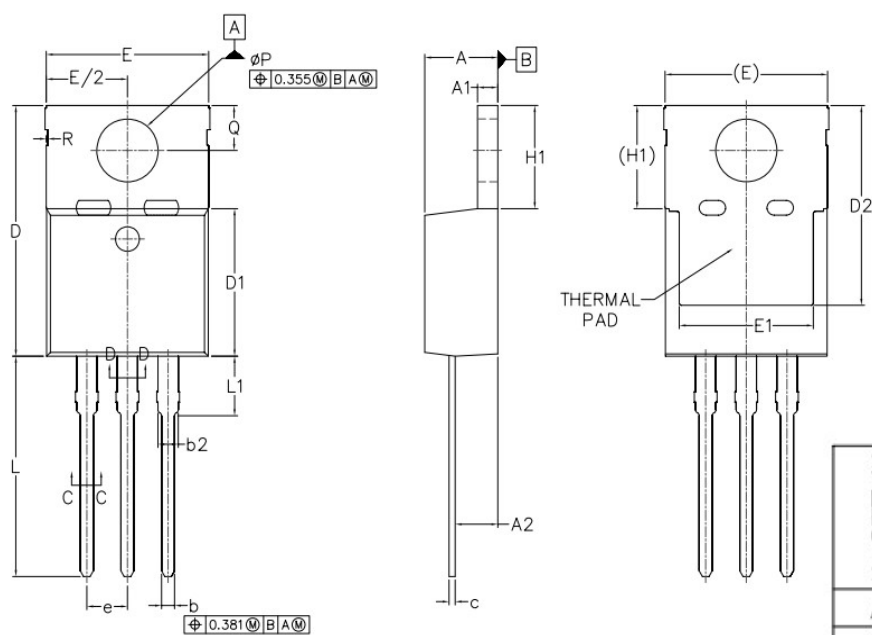


Fig.12 I_D vs. Junction Temperature^③



•TO-220 Package Outline



SYMBOLS	COMMON	
	MM	
	MIN.	MAX.
A	3.556	4.826
A1	0.508	1.397
A2	2.032	2.921
b	0.381	1.016
b1	0.381	0.965
b2	1.143	1.778
b3	1.143	1.727
c	0.356	0.610
c1	0.356	0.559
D	14.224	16.510
D1	8.382	9.017
D2	12.042	12.878
E	9.652	10.668
E1	6.858	8.890
e	2.540 BSC.	
H1	5.842	6.858
L	12.700	14.732
L1	3.560	4.060
ϕP	3.810	3.860
Q	2.540	3.048
R	0.127 BSC.	

Note:

- ① Pulse : $V_{GS}=+20V/-20V$, Duty cycle=50%, $T_j=175^{\circ}C$, $t=1000$ hours; For DC , the following test conditions can be passed: $V_{GS}=+20V/-10V$, $T_j=175^{\circ}C$, $t=1000$ hours;
- ② Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate;
- ③ Practically the current will be limited by PCB, thermal design and operating temperature. $V_{GS}=10V$.

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Revision History

Version	Date	Change
A	2022.1.6	New
B	2022.11.5	1.Fig.1~Fig11 modify 2.Idm corrected 3.Add Reach,HF figure 4.add "It is suitable for automotive application." 5.modify as "total time<10s"
C	2023.12.21	Correct Pakage Outline Dimensiom
D	2024.11.6	RDSon modified.